

**Series: Embedded Antenna** 

### **TECHNICAL DATA SHEET**

Description: 2.4/5GHz Dualband WiFi SMT

Antenna

PART NUMBER: W3715



### **Features:**

Frequency: 2.4-2.5/4.9-6GHz

• Gain: 3.7/5.5dBi

Size: 11 x 7 x 16 mm

SMT compatible

Packing: Tape&Reel

· RoHS compliant

## **Applications:**

- WiFi, ISM 2.4/5GHz
- · Bluetooth, Zigbee, BLE
- DSRC 5.925GHz
- IoT and M2M devices
- Portable Electronics
- · Security, Transportation

All dimensions are in mm / inches

Issue: 1812

In the effort to improve our products, we reserve the right to make changes judged to be necessary. CONFIDENTIAL AND PROPRIETARY INFORMATION

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## **ELECTRICAL SPECIFICATIONS**

Frequency 2.4-2.5GHz, 4.9-6GHz

Nominal Impedance  $50\Omega$ 

VSWR 2:1

Peak Gain (2.4-2.5GHz) 3.7dBi +/- 1 dB

Peak Gain (4.9-6GHz) 5.5dBi+/- 1 dB

Efficiency 74%

Power withstanding 5W

Radiation Pattern Omni



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## **MECHANICAL SPECIFICATIONS**

Material SUS304

Thickness 0.5 mm

Finish Ni plating 1-3 um

Weight 0.56 g

Size(L X W X H) 11(0.43)X 7(0.28) X 16(0.63) mm(inch)

Fixing system SMT

## **ENVIRONMENTAL SPECIFICATIONS**

Operating temperature

-40/+85 ° C





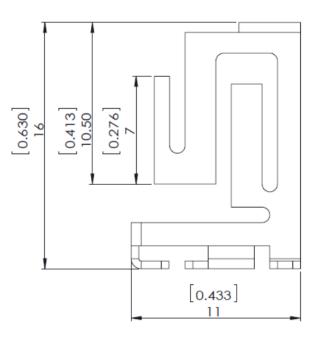
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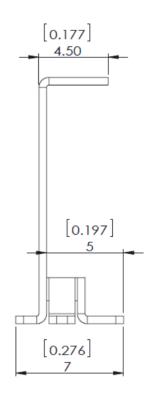
**Antenna** 

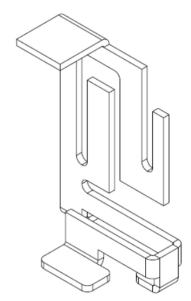
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## **MECHANICAL DRAWING**









Description: 2.4/5GHz Dualband WiFi SMT

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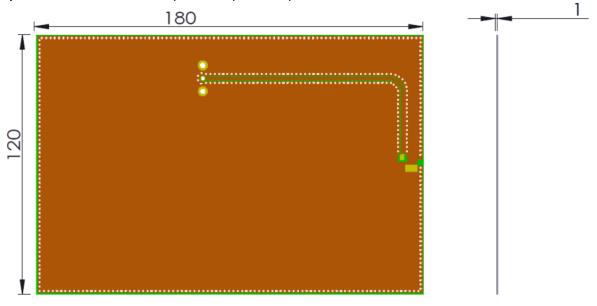
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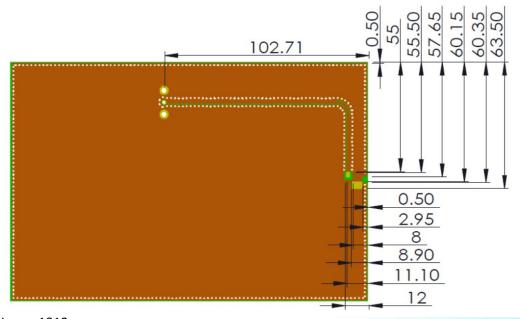
## **OTHER SPECIFICATIONS**

## **PCB LAYOUT:**

1, PCB material, FR4, size, 180X120X1mm



# Clearance area (Top)



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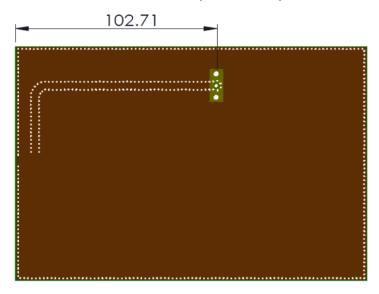
**Antenna** 

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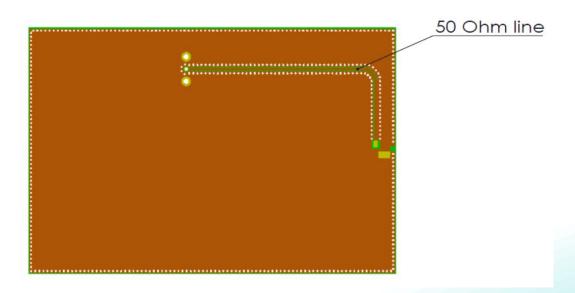
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## **OTHER SPECIFICATIONS**

# 3, Clearance area (Bottom)



## 4, PCB Features



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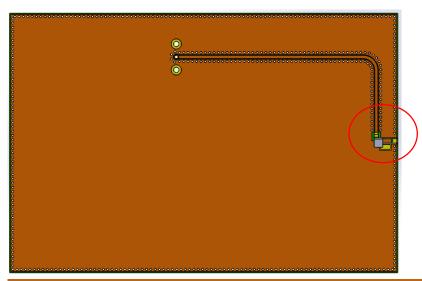
**Antenna** 

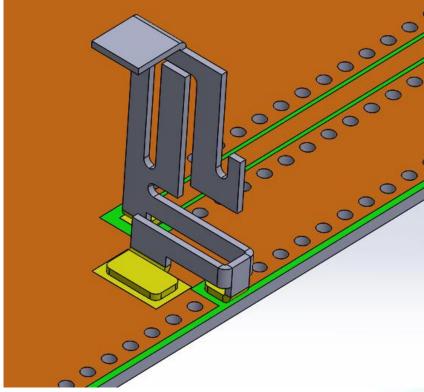
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## **OTHER SPECIFICATIONS**

## 3, Antenna on test PCB









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### **OTHER SPECIFICATIONS**

# Recommendation for reflow soldering process

Printing stencil thickness 0,15 - 0,25 mm is recommended for the solder paste. The maximum soldering temperature should not exceed 260°C. The temperature profile recommendations for reflow soldering process is presented in the Figures 1 and 2. The reflow profile presented in figure 1 describes minimum reflow temperatures. The reflow profile presented in figure 2 describes maximum reflow temperatures. located at the center of the coverage area.

	Method of heat transfer	Controlled hot air convection
1	Average temperature gradient in preheating	2.5 °C/s
2	Soak time	2-3 minutes
3	Max temperature gradient in reflow	3 °C/s
4	Time above 217 °C	Max 30 sec
5	Peak temperature in reflow	230 °C for 10 seconds
6	Temperature gradient in cooling	Max -5 °C/s

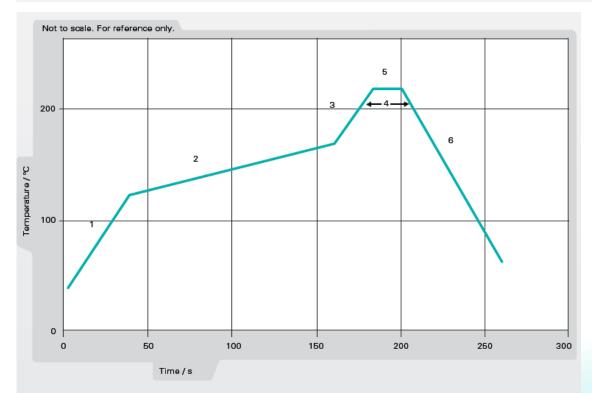


Figure 1. Minimum temperature profile recommendation for reflow soldering process





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	Method of heat transfer	Controlled hot air convection
1	Average temperature gradient in preheating	2.5 °C/s
2	Soak time	2-3 minutes
3	Max temperature gradient in reflow	3 °C/s
4	Time above 217 °C	Max 60 sec
5	Time above 230 °C	Max 50 sec
6	Time above 250 °C	Max 10 sec
7	Peak temperature in reflow	260 °C for 5 seconds
8	Temperature gradient in cooling	Max -5 °C/s

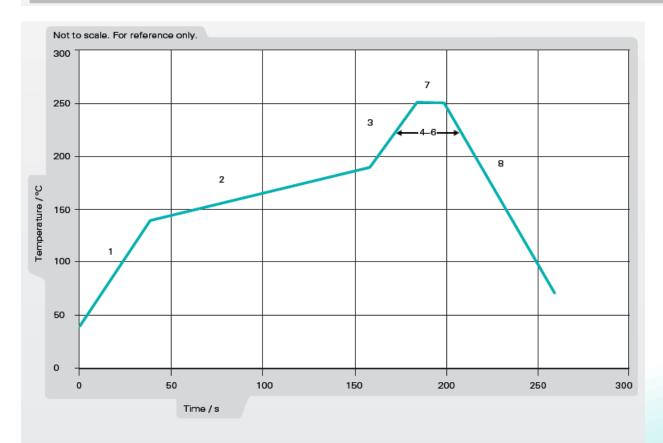


Figure 2. Maximum temperature profile recommendation for reflow soldering process



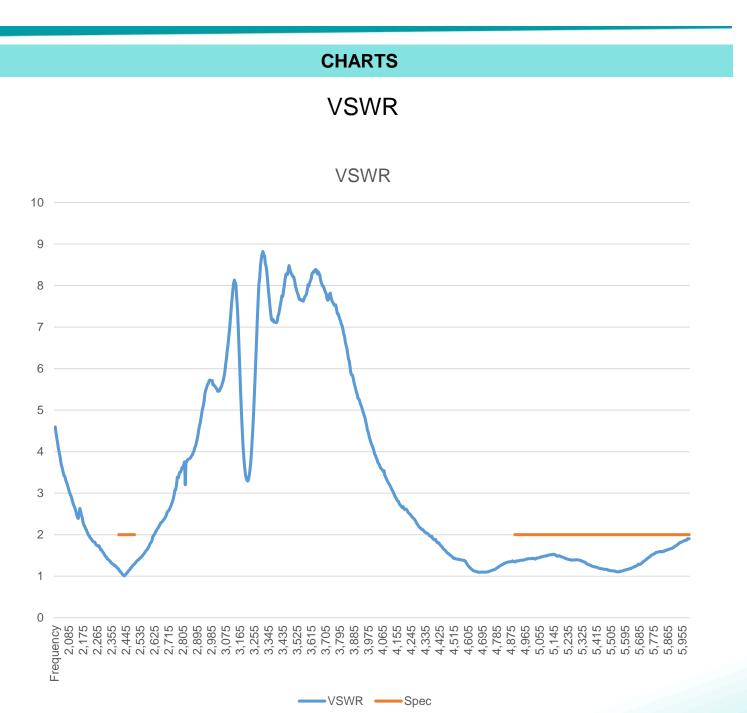


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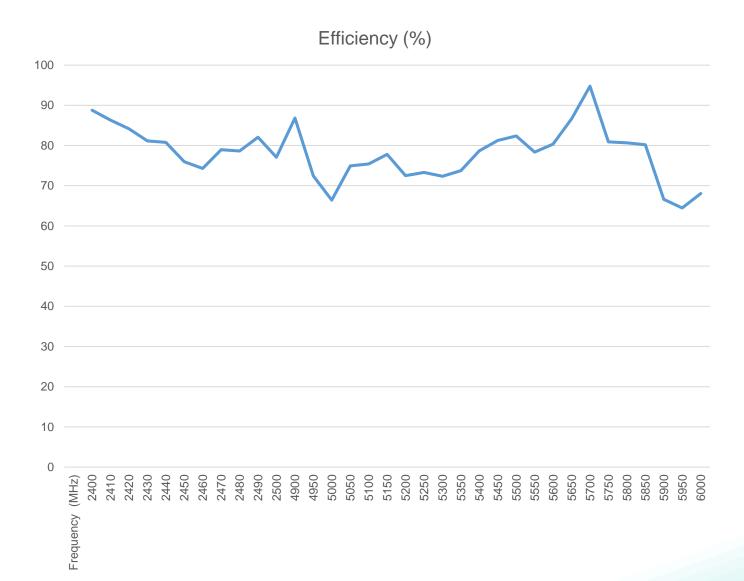
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### **CHARTS**

# Efficiency(%)







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### **CHARTS**

# Peak Gain (dBi)







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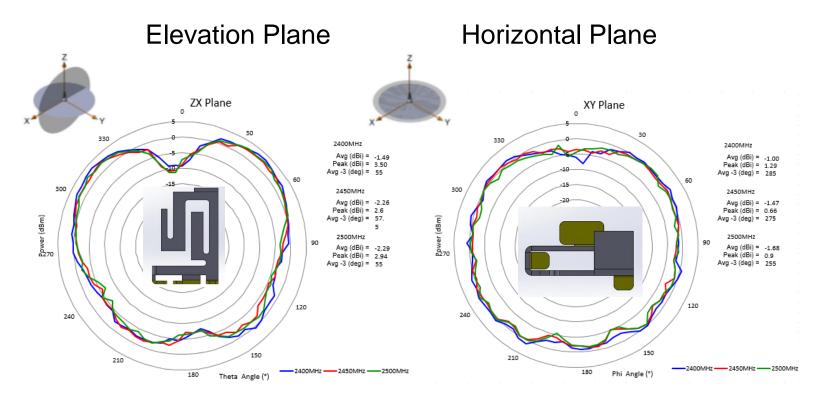
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## **CHARTS**

# Free Space Radiation Pattern





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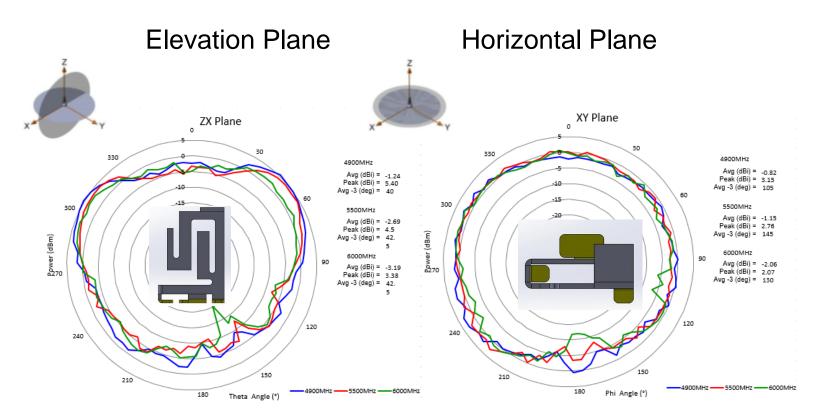
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## **CHARTS**

# Free Space Radiation Pattern





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## **PACKAGING**

Tape and Reel packing: 200 PCS/ Tape and Reel 400PCS/ Carton box

Tape Width: 32mm

Tape Material: Polystyrene





### **ПОСТАВКА** ЭЛЕКТРОННЫХ КОМПОНЕНТОВ

Общество с ограниченной ответственностью «МосЧип» ИНН 7719860671 / КПП 771901001 Адрес: 105318, г.Москва, ул.Щербаковская д.3, офис 1107

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